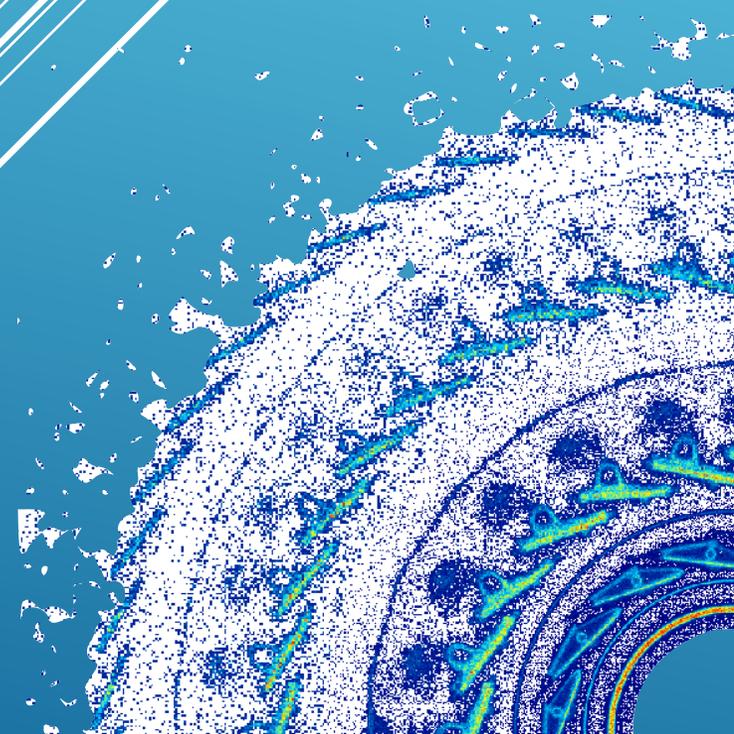


# THE UPGRADED PIXEL DETECTOR OF THE ATLAS EXPERIMENT FOR RUN-2 AT THE LHC

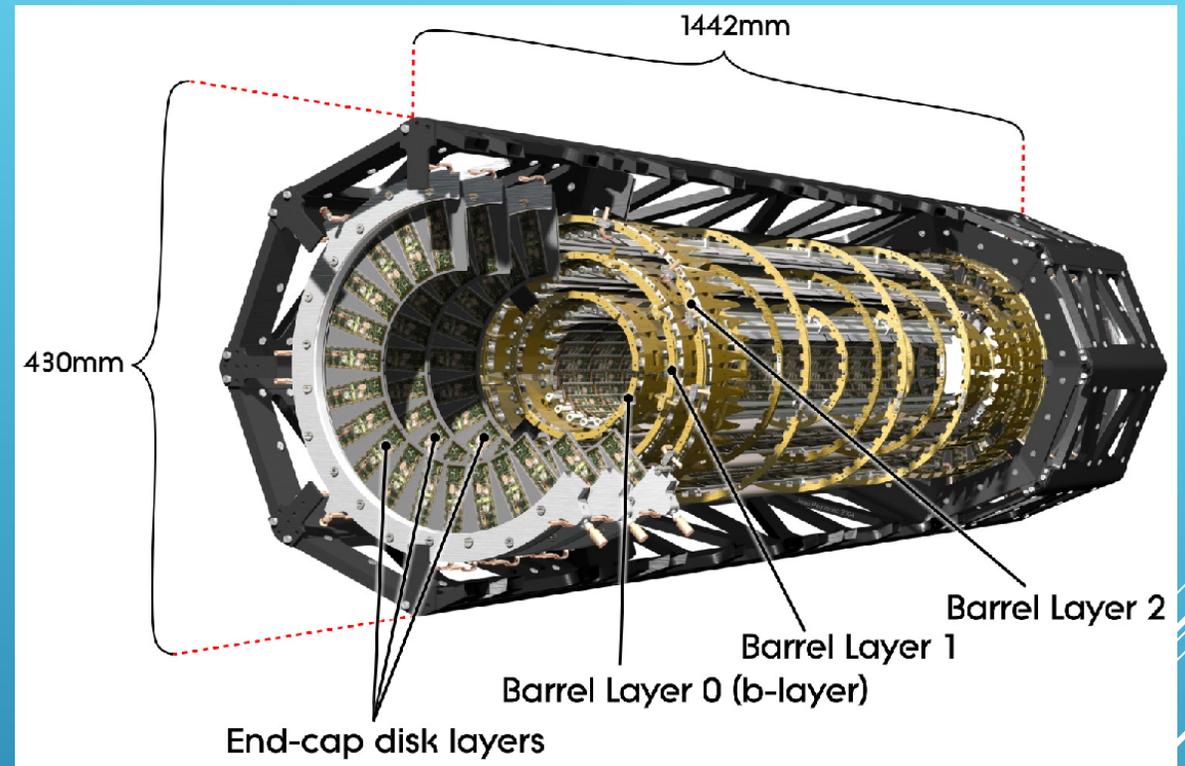
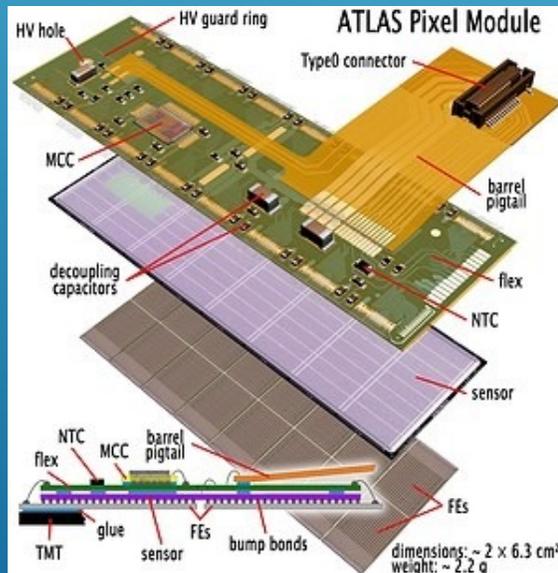
MARIO PAOLO GIORDANI

Università degli Studi di Udine — INFN Trieste

on behalf of the ATLAS Collaboration



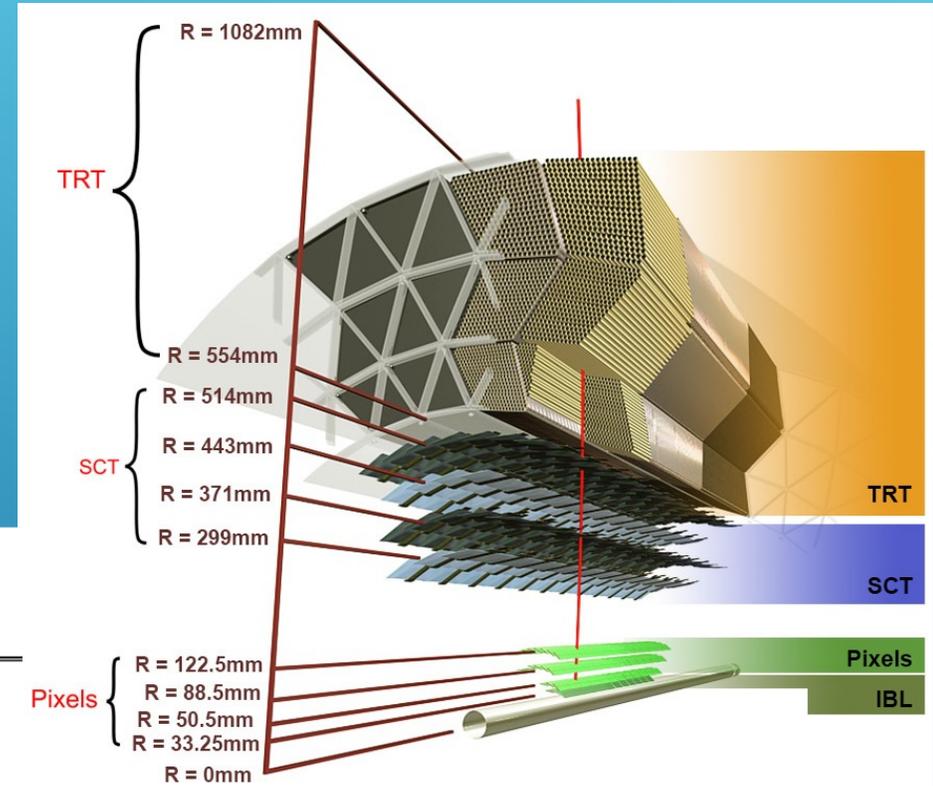
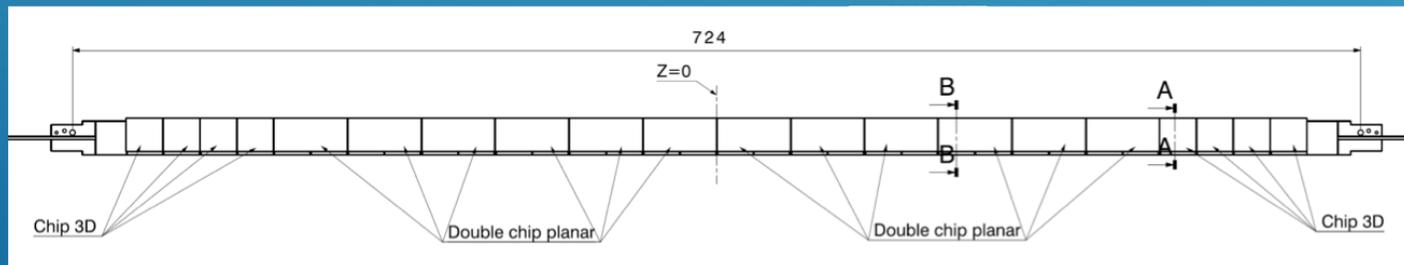
- ▶ Innermost part of ATLAS Inner Detector
- ▶ 3 cylindrical layers, 5.05-12.25cm from beamline
- ▶ 3 disks per side, 49.5-65cm from IP
- ▶ 1744 identical hybrid modules
  - ▶ n-in-n planar sensors, 47232  $50 \times 400 \mu\text{m}^2$  pixels
  - ▶ 16 FE-I3 chips/sensor, each reading  $18 \times 160$  pixels
  - ▶ 40-160Mbps transmission lines to back-end



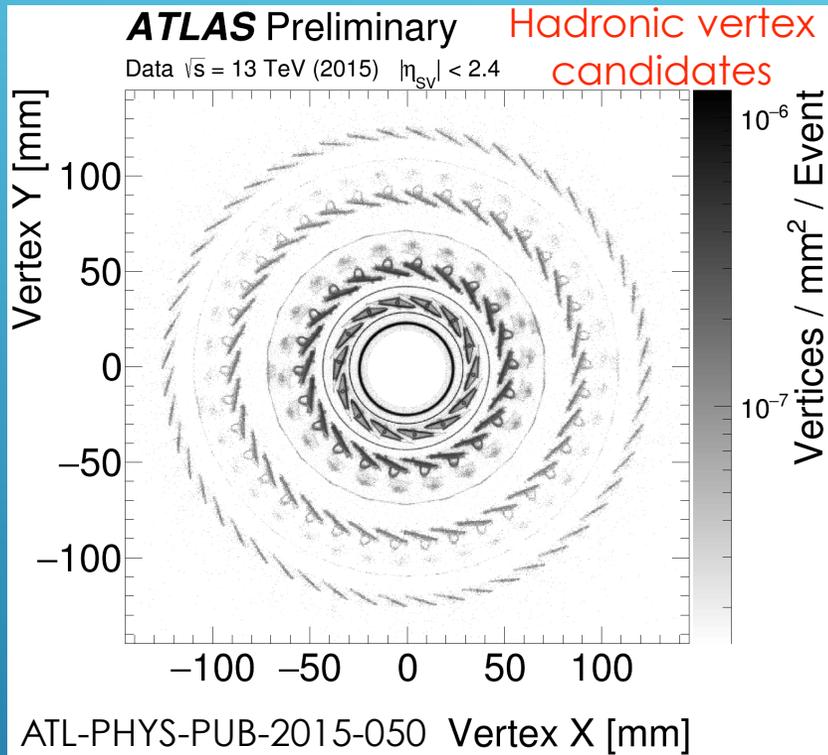
- ▶ Data taking with efficiency of 97.5% to 95% across Run-1
- ▶ 88 disabled modules at the end of the run
- ▶ Detector refurbishment (new services) at the end of Run-1
  - ▶ 55 recovered modules, doubled Layer-1 fibres (bandwidth to 160Mbps)

# LAYOUT: RUN-1 PIXEL

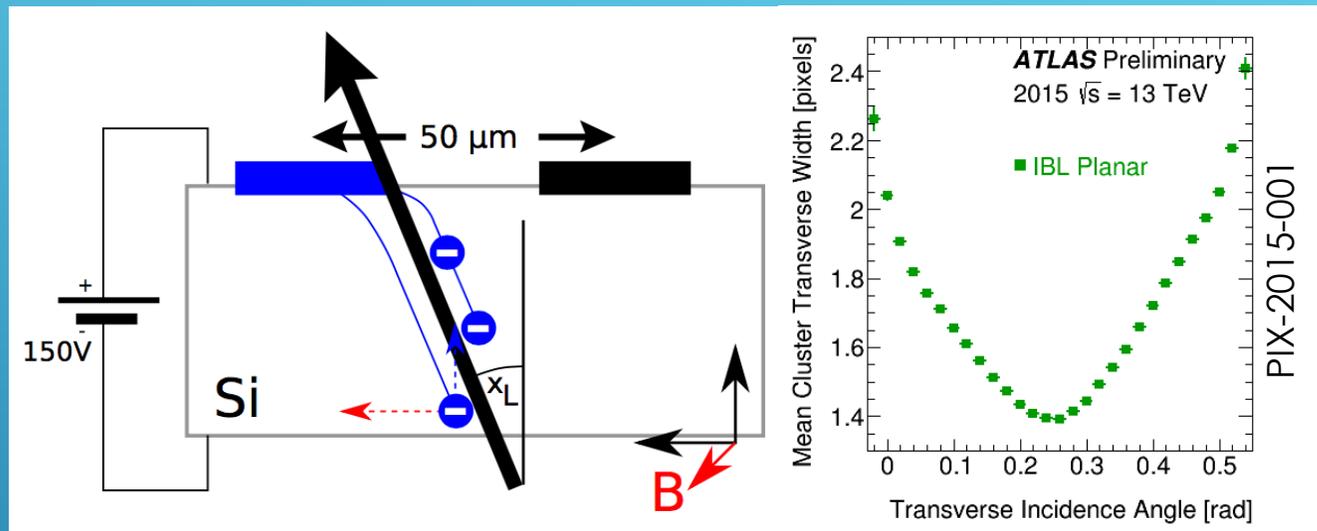
- ▶ Motivated as B-Layer back-up against failures due to radiation and readout inefficiencies
- ▶ Directly clamped to new narrower beam-pipe at 3.325cm from beamline
- ▶ Additional material compensated by enhanced tracking performance
- ▶ Major technological challenge
  - ▶ insertion in pixel package (2mm mechanical clearance)
  - ▶ higher particle flux (i.e. occupancy, radiation) than B-Layer
- ▶ New FE-I4 readout chip, mixed sensor technology
  - ▶ 160Mbps transmission to back-end
  - ▶ fitting common sensor layout ( $80 \times 336$   $50 \times 250 \mu\text{m}^2$  pixel matrix)
  - ▶ 200 $\mu\text{m}$ -thick n-in-n double chip planar modules
  - ▶ 230 $\mu\text{m}$ -thick n-in-p 3D single chip modules



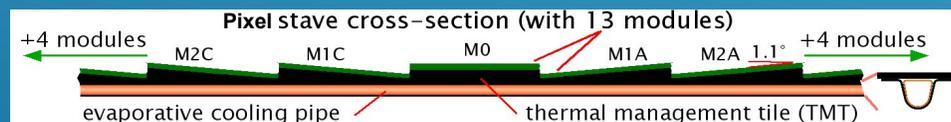
# LAYOUT: INSERTABLE B-LAYER (IBL)



- ▶ Turbine layout for hermetic track coverage
  - ▶ Stave tilt angles chosen to compensate for Lorentz force
  - ▶ Minimise charge sharing between pixels

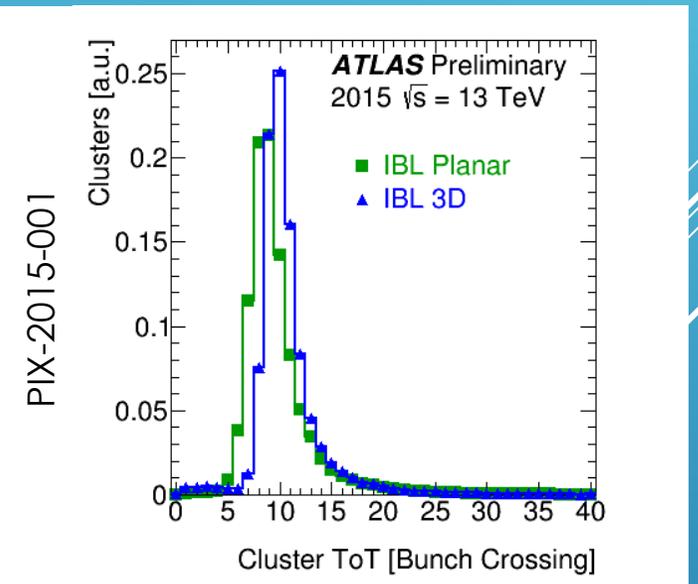
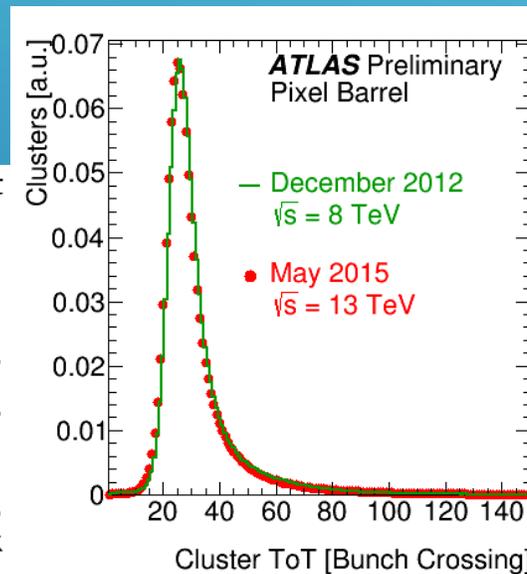
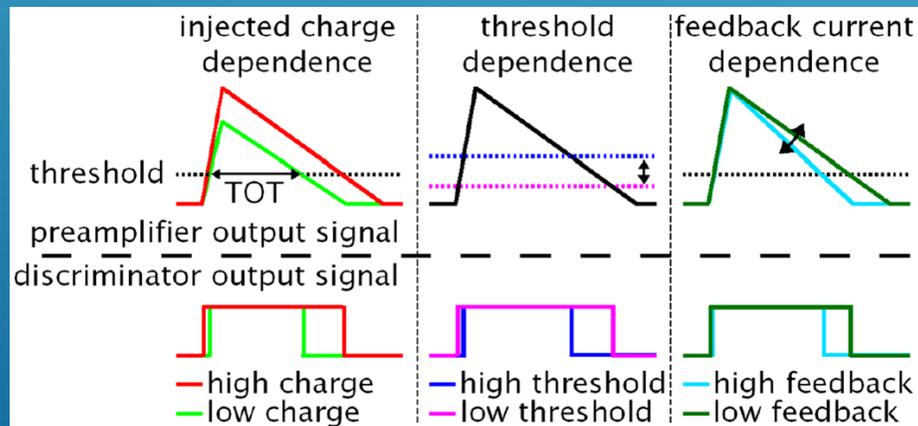


- ▶ Module shingling in pixel detector not achievable in IBL due to very limited clearance
  - ▶ Longitudinal hermeticity addressed by slim edge sensor design



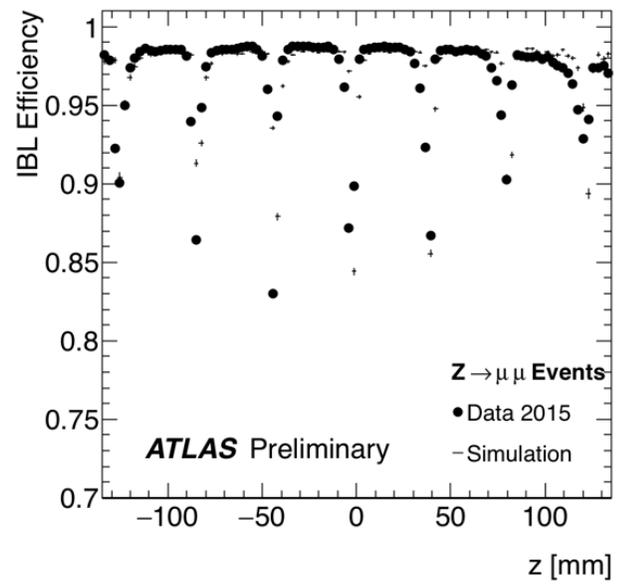
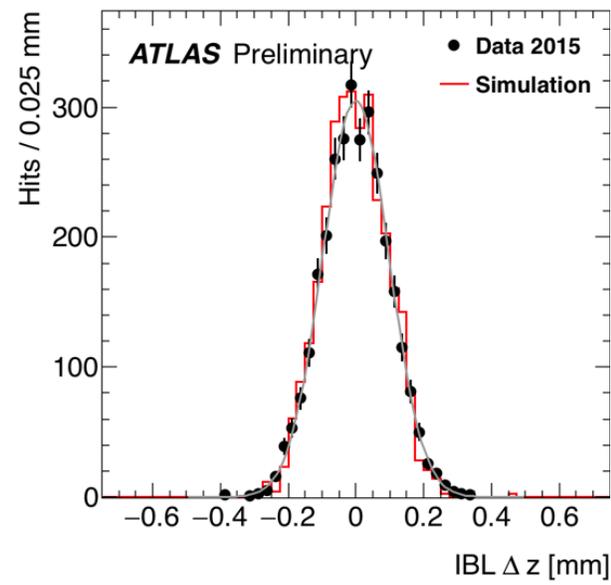
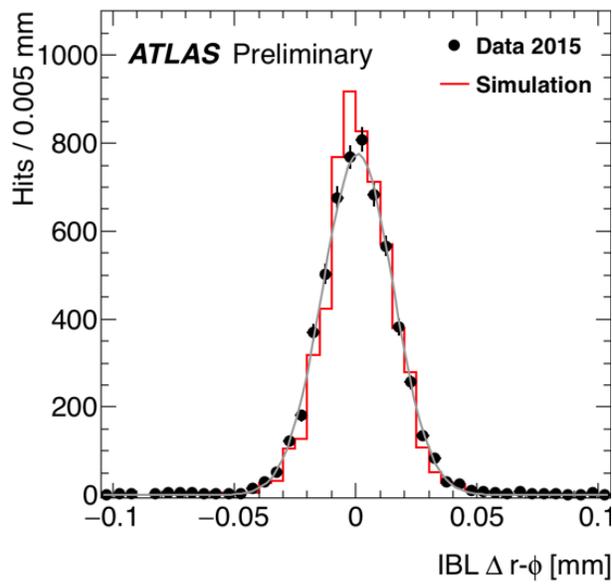
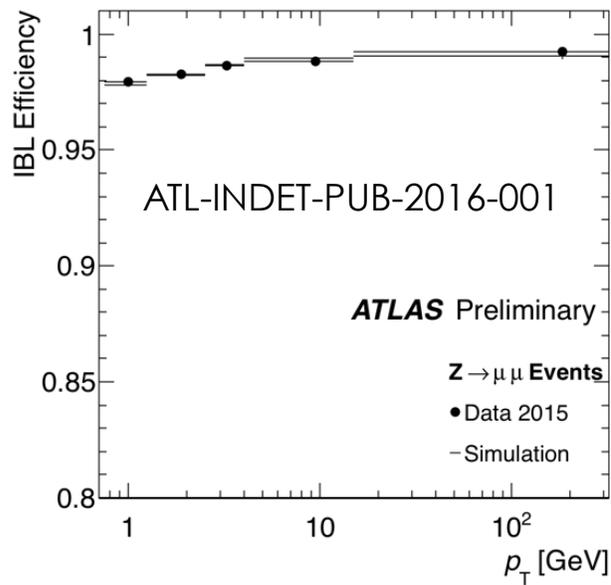
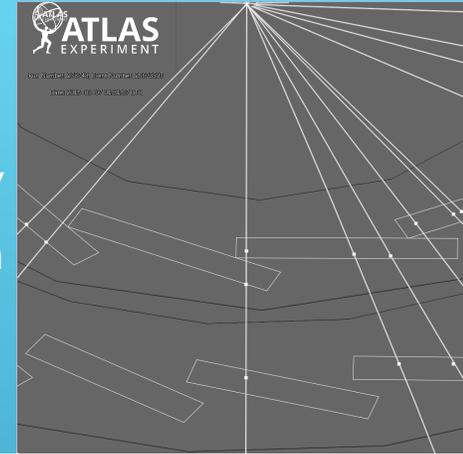
# LAYOUT ZOOM: PIXEL VS IBL

- ▶ FE-I3 and FE-I4 are digital readout chips
- ▶ Signals from collected charge is digitised after amplification
  - ▶ detector FE returns Time-over-Threshold (ToT): duration of signal above analog threshold in units of 25ns
  - ▶ rising edge at threshold assigns timestamp to hit
  - ▶ further possibility of controlling occupancy by acting on digital threshold (i.e. rejecting hits with small ToT)
  - ▶ requires charge-ToT calibration for operating detector and for comparison with MC
- ▶ ToT information is used in tracking
  - ▶ track association based on NN algorithm exploiting cluster shape/charge distribution



# DIGITAL READOUT: TOT

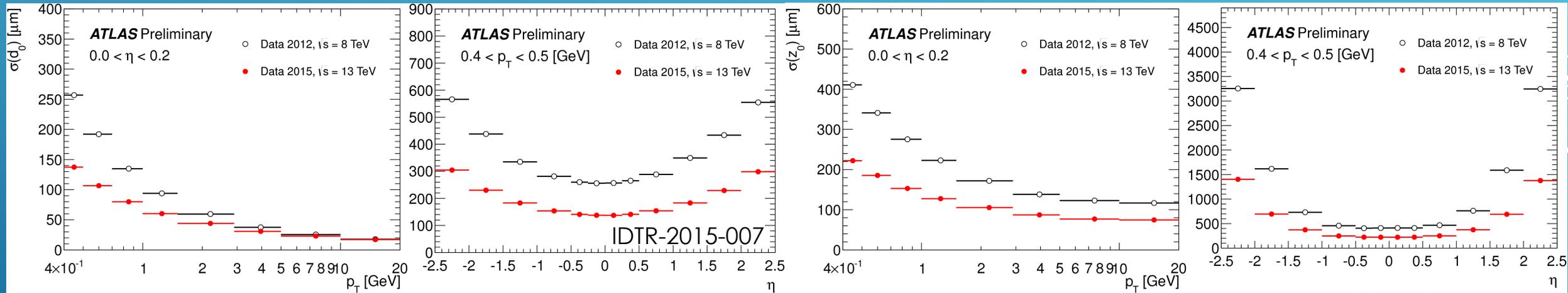
- ▶ Based on  $Z \rightarrow \mu\mu$  data collected in 2015 compared with MC
- ▶ Hit reconstruction + track association efficiency greater than 98%
- ▶ Transverse and longitudinal hit spatial resolutions of 10.0 and 66.5  $\mu\text{m}$  respectively
  - ▶ from sample of tracks traversing overlapping modules and having hits in both of them
  - ▶ single hit resolution from corrected hit position difference,  $\Delta r-\phi$  and  $\Delta z$ :  $\sigma_{point} = \sigma_{\Delta} / \sqrt{2}$
- ▶ Efficiency along z probing slim edge design, consistent with expectations



# IBL EFFICIENCY AND SPATIAL RESOLUTION

- ▶ 4-layer 92Mpixel tracker at work!
- ▶ 2015 Run-2 vs Run-1 data comparison
  - ▶ enhanced tracking performance over all acceptance
  - ▶ overall improvement on impact parameter resolution by approximately a factor 2, in line with simulations
    - ▶ loose track selection
    - ▶ transverse and longitudinal impact parameter unfolded to remove contribution from vertex resolution
  - ▶ beneficial effects of reduced material (Be beam pipe), distance from IP and longitudinal pitch

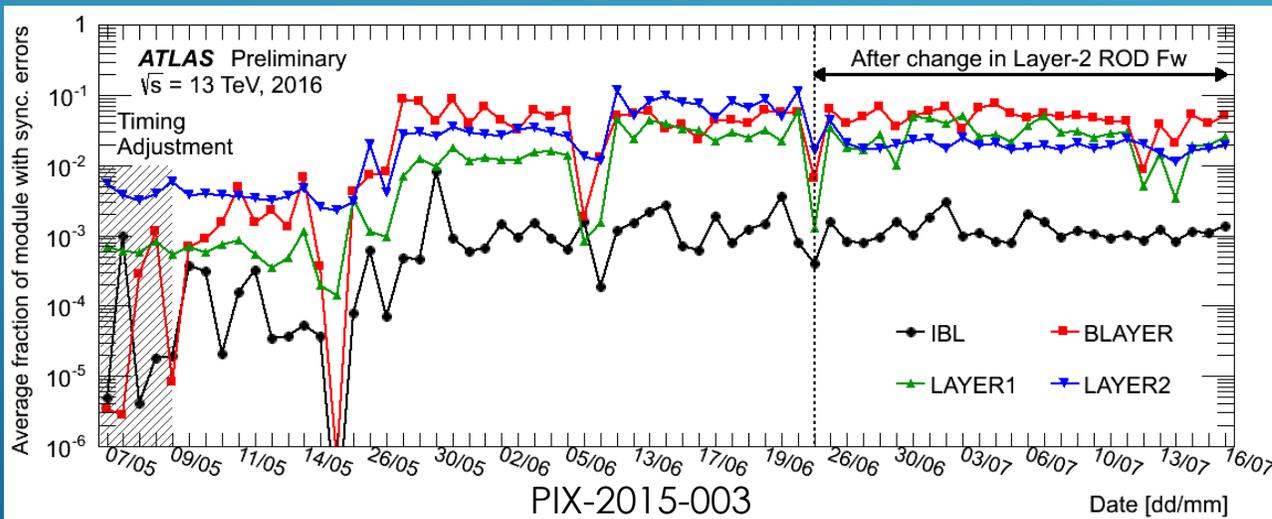
see S. Pagan Griso's talk on Aug 6  
 New developments in track reconstruction  
 for the ATLAS experiment for Run-2 of the LHC



- ▶ This translates in a +10% on  $b$ -tagging efficiency for similar background rejection

# PIXEL+IBL PERFORMANCE

- ▶ Good overall data-taking efficiency
  - ▶ Pixel/IBL can sustain high rates (85kHz) with low dead-time (less than 2-3%)
  - ▶ there have been several improvements during last year targeting mainly IBL and Layer-2
  - ▶ B-Layer is under the lens now
- ▶ Tracking efficiency affected by synchronisation errors
  - ▶ very sensitive to beam conditions (instantaneous luminosity, number of interactions per BC)
- ▶ Ongoing work on automatic recovery procedures expected to improve the situation



## ATLAS pp 25ns run: April-July 2016

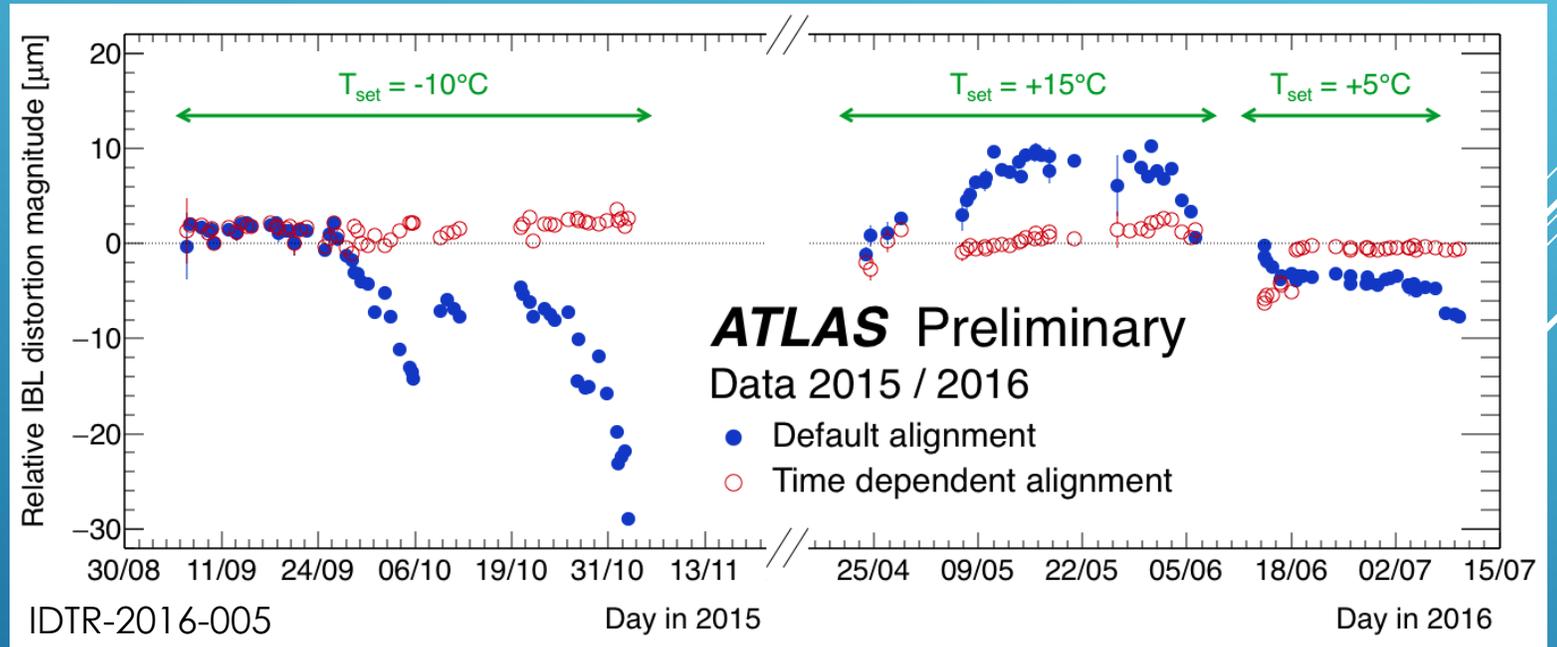
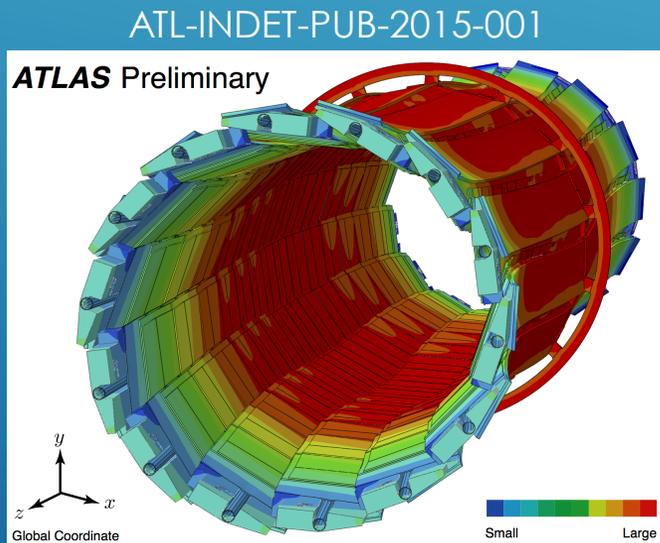
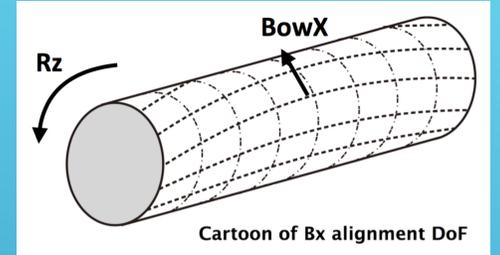
Inner Tracker			Calorimeters		Muon Spectrometer				Magnets	
Pixel	SCT	TRT	LAr	Tile	MDT	RPC	CSC	TGC	Solenoid	Toroid
98.9	99.9	100	99.8	100	99.6	99.8	99.8	99.8	99.7	93.5

**Good for physics: 91-98% (10.1-10.7 fb<sup>-1</sup>)**

Luminosity weighted relative detector uptime and good data quality efficiencies (in %) during stable beam in pp collisions with 25ns bunch spacing at  $\sqrt{s}=13$  TeV between 28th April and 10th July 2016, corresponding to an integrated luminosity of 11.0 fb<sup>-1</sup>. The toroid magnet was off for some runs, leading to a loss of 0.7 fb<sup>-1</sup>. Analyses that don't require the toroid magnet can use that data.

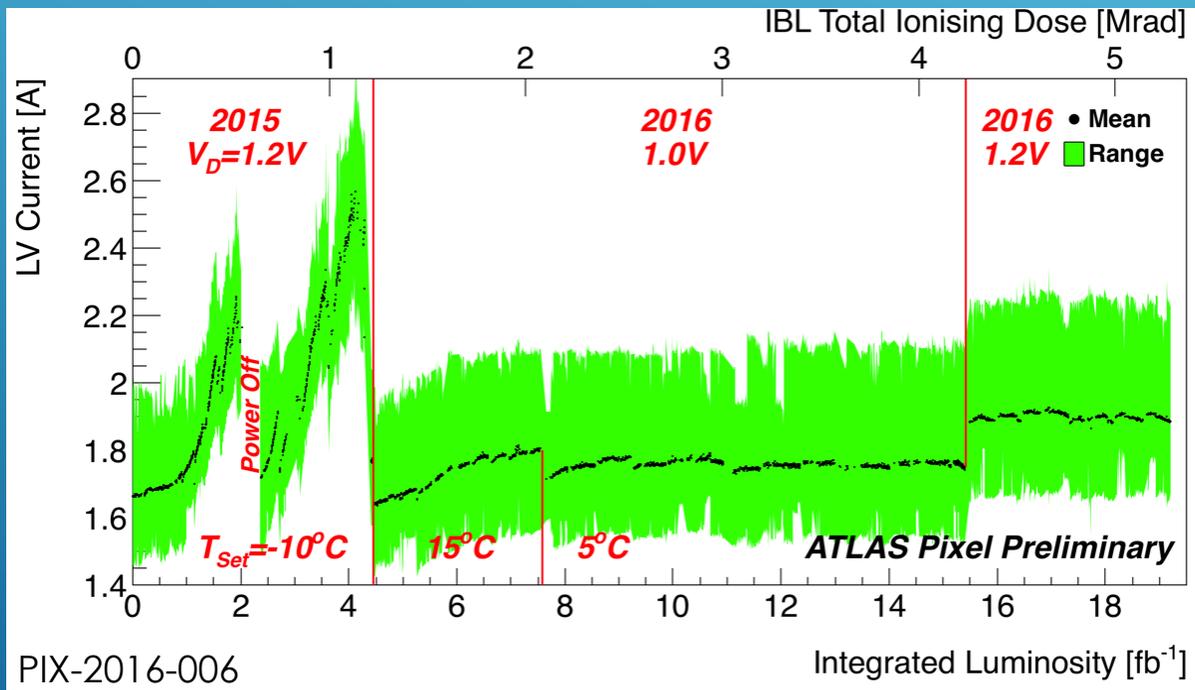
# DETECTOR OPERATIONS

- ▶ IBL distortion discovered during 2015 cosmic runs, correlated to temperature changes ( $10\mu\text{m}/\text{K}$ )
- ▶ Induced by CTE mismatch between stave carbon structure and Cu/Al flex, reproduced by FEA
  - ▶ protect detector wrt rapid thermal cycles in order to prevent mechanical failures
- ▶ Corrected by Inner Detector alignment procedure
  - ▶ necessary if temperature varies by more than 0.2K during run
  - ▶ after September, in-run alignment procedure recovers tracking performance

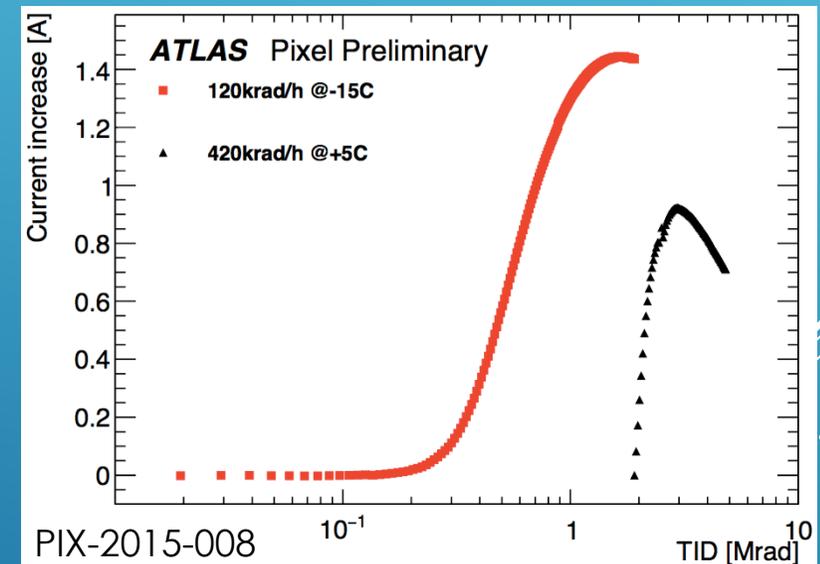


# OPERATIONAL ISSUES: IBL DISTORTION

- ▶ Steep rise in IBL LV currents observed in 2015 since the beginning of September
  - ▶ potentially catastrophic due to temperature increase and risk of electrical failure
- ▶ Correlated to 130nm n-MOS FE transistor leakage current
  - ▶ hole trapping in bulk oxide dominating the beginning of irradiation, fast annealing
  - ▶ interface trap generation dominating at high TID (rebound effect), annealing at high temperatures



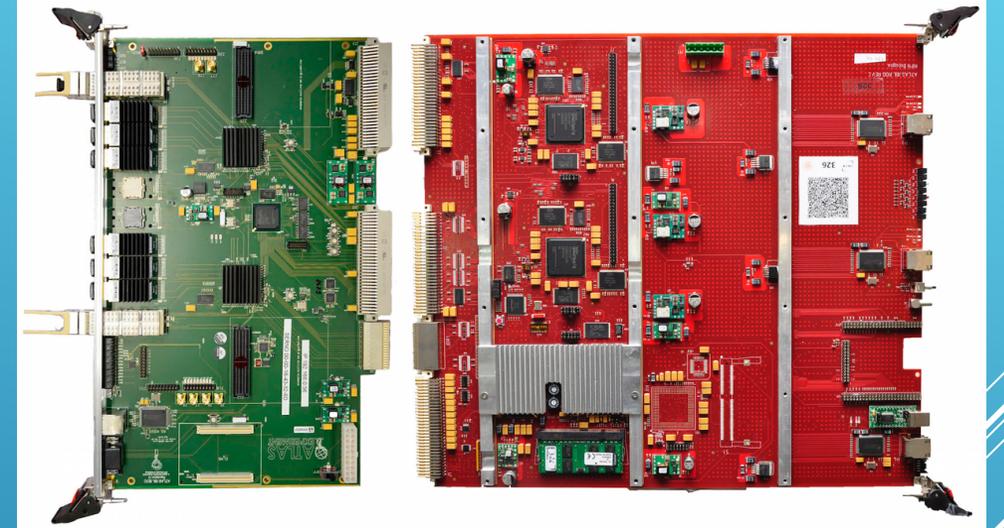
- ▶ Ad-hoc irradiation campaign on FE samples
- ▶ Effect controlled by operating temperature



# OPERATIONAL ISSUES: IBL LV CURRENTS

10

- ▶ Bandwidth limitations in back-end transmission observed already at the end of Run-1
- ▶ Layer-1 and Layer-2 back-end electronics subject of upgrade in 2015-2016
  - ▶ relying on recent hardware used for IBL and capable of up to 160Mbps transmission speed
- ▶ Installation completed for Layer-2
  - ▶ exploits up to 80Mbps bandwidth due to available fibres
  - ▶ successfully recommissioned in 2016
- ▶ Upgrade will continue with Layer-1
  - ▶ new services deployed during IBL installation included double fibres for Layer-1 (160Mbps achievable)
- ▶ Might want to extend the same treatment to the rest of the detector (B-Layer and disks)
  - ▶ opportunity of running more recent and robust hardware to the 2020+
    - ▶ we are expected to collect 10× more data till the end of Run-3
  - ▶ uniform readout system easier to maintain
  - ▶ benefit from more powerful diagnostic tools in order to prevent issues in data-taking

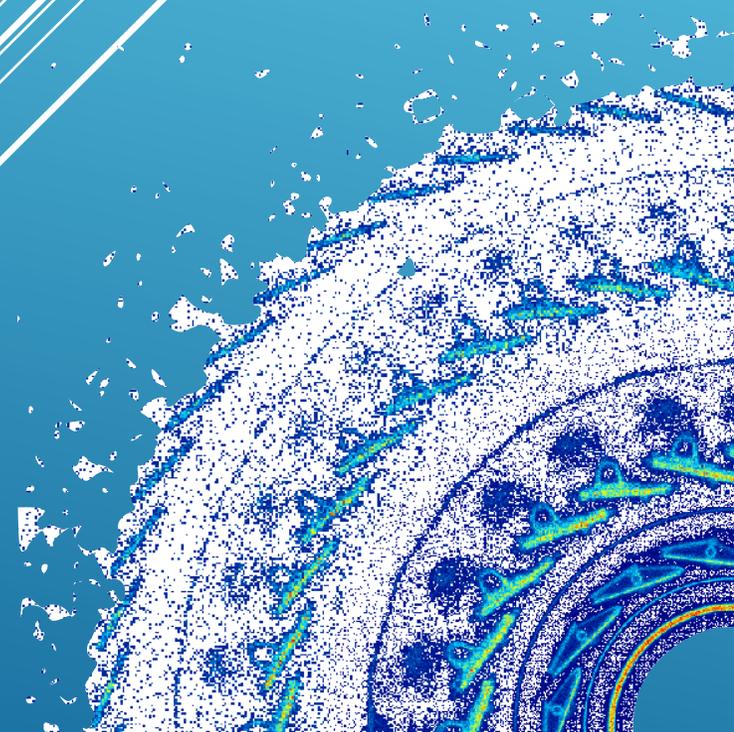


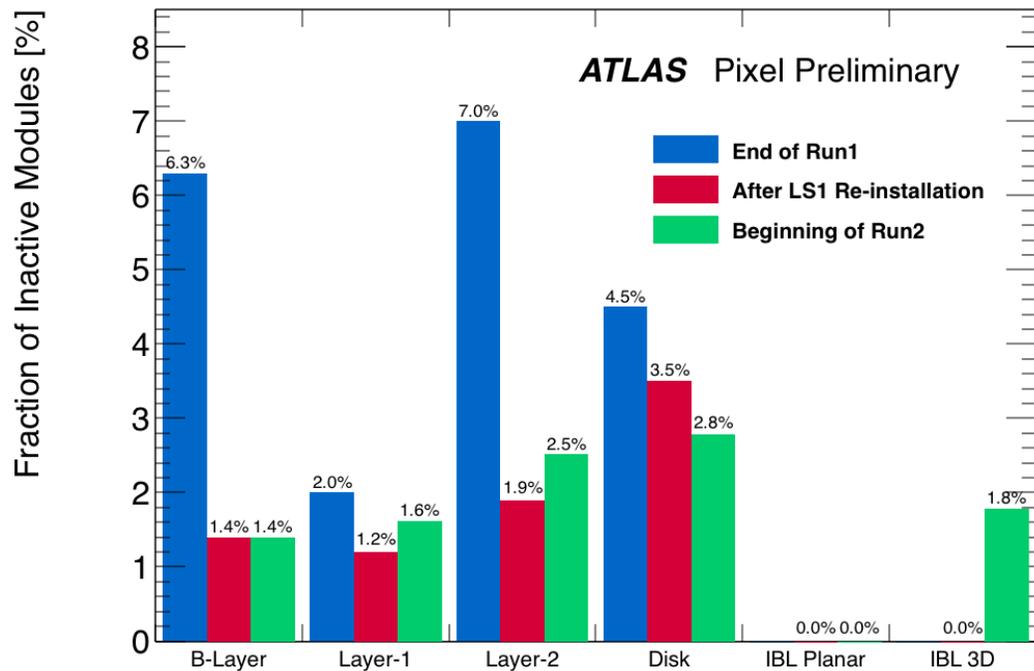
# TOWARDS THE FUTURE

- ▶ Successful operation of ATLAS 4-layer pixel detector to (almost) design conditions in 2016
  - ▶ 13TeV, peak luminosity exceeding  $1.1E34\text{cm}^{-2}\text{s}^{-1}$  and average  $\mu$  consistently above 40 at beginning of fill
  - ▶ data taking efficiency steadily above 95% with trigger rates in the 80kHz's and dead time of 2-3%
- ▶ So far IBL has complemented B-Layer, boosting the tracking performance observed in Run-1
  - ▶ precision tracking and vertexing are at the basis of any discovery (or precision measurement)
- ▶ However, detector operation is becoming increasingly challenging with LHC performance
  - ▶ there is a long way to go before the next major upgrade in the years 2020+
  - ▶ it will be important to preserve and tune the detector in order to operate it at its optimal performance
  - ▶ we are getting ready to operate the detector beyond its design specs (thanks to an outperforming LHC)
    - ▶ this requires enhancing our diagnostic capabilities in order to promptly mitigate problematic situations
- ▶ There are lessons to be learnt for the future, when detectors will face harsher conditions
  - ▶ so far we faced (and solved) some serious issues thanks to the dedication of a great team
- ▶ We must all remember that good physics necessarily requires good detector operations
  - ▶ and that operation experience is necessary to build future detectors

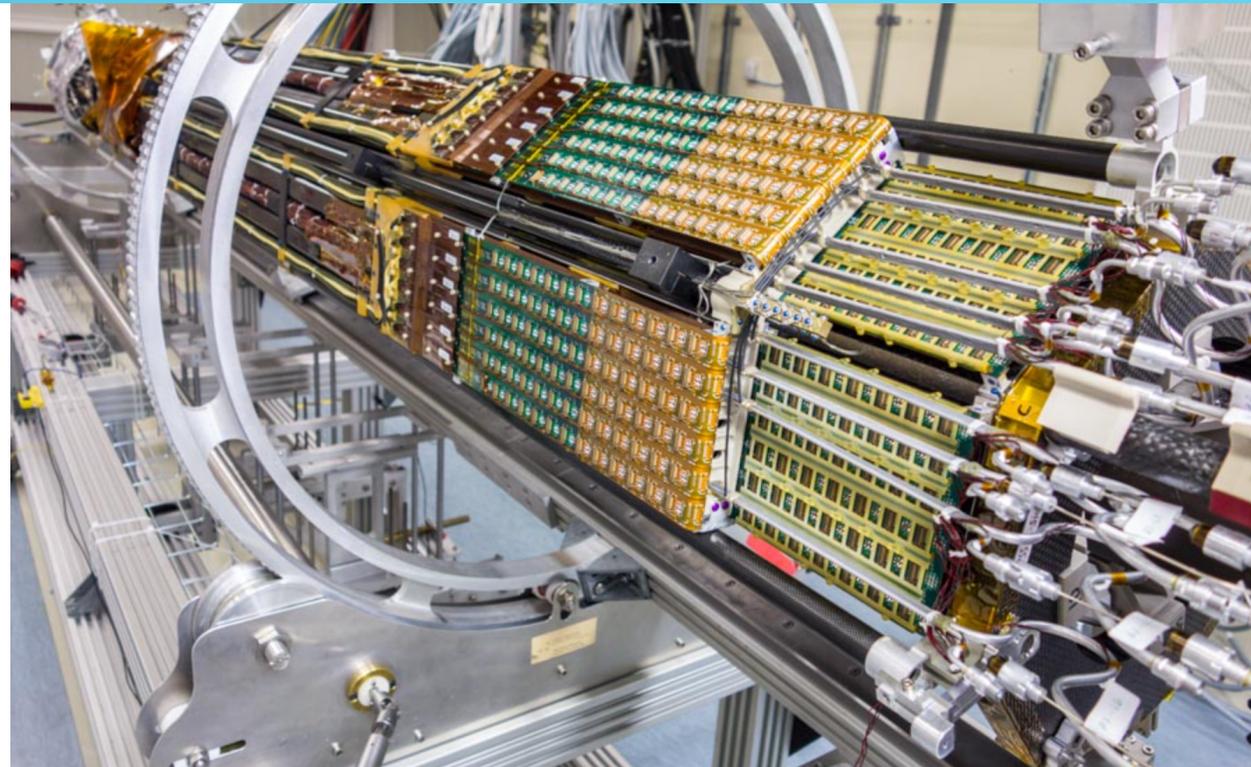
# CONCLUSIONS

# BACK-UP MATERIAL





PIX-2015-009

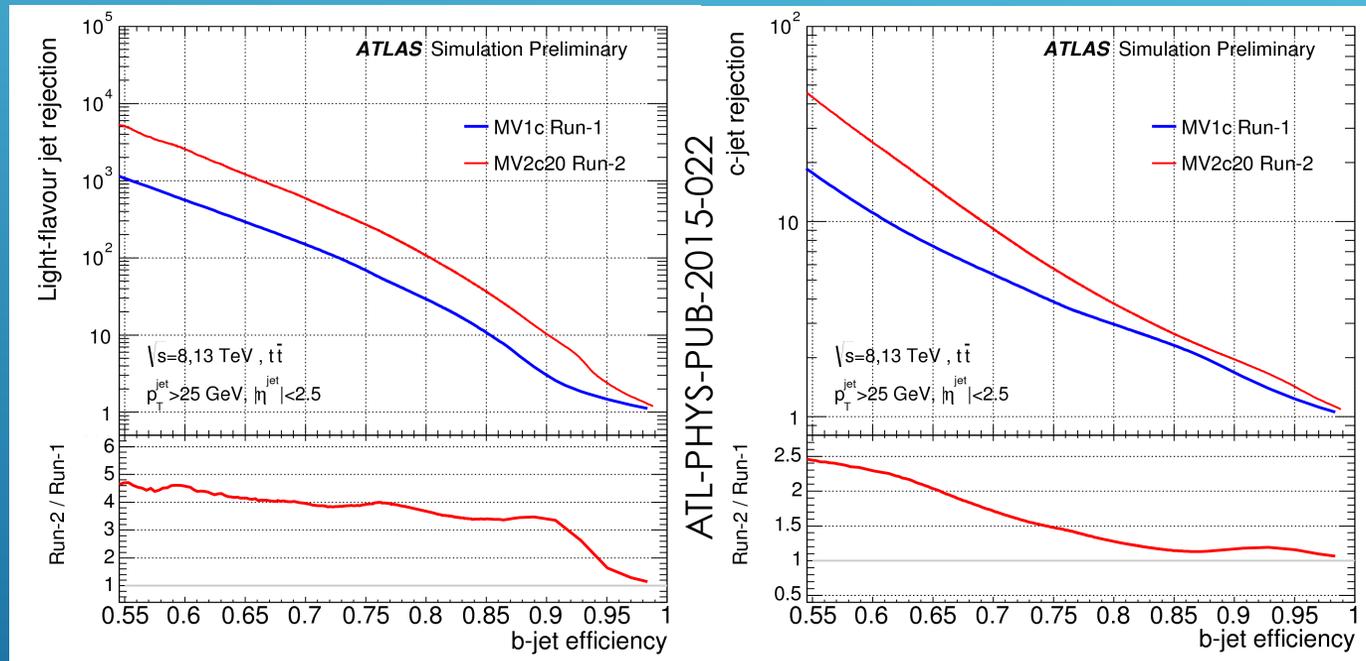


- ▶ New Service Quarter Panels installed during LS1
- ▶ Electrical-optical conversion moved outside ID volume → improved accessibility
- ▶ Accessible connections and services of faulty modules repaired
- ▶ Added fibres → doubled readout speed capabilities for Layer-1 (2×80Mbps)

# BACK-UP: NSQP AND PIXEL REFURBISHMENT

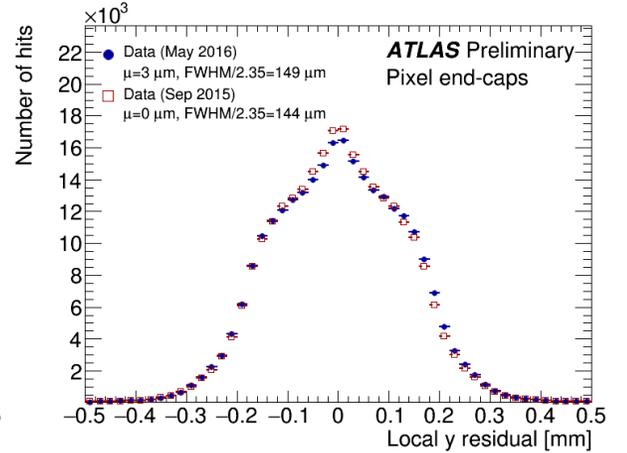
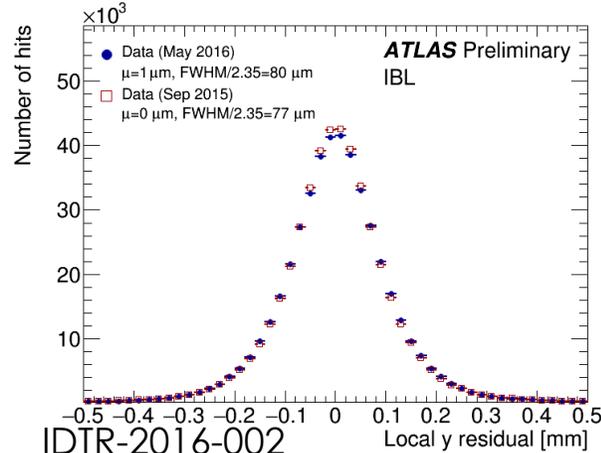
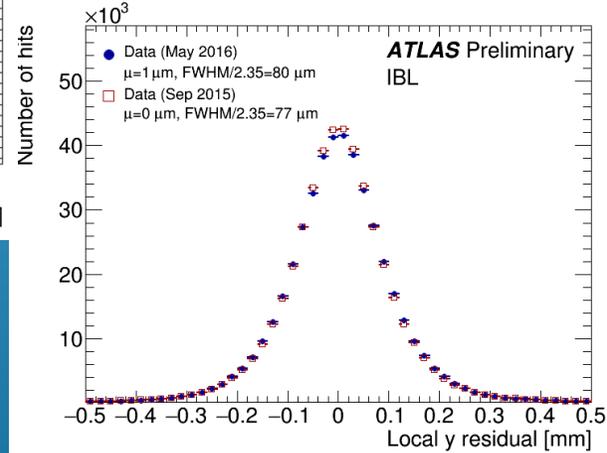
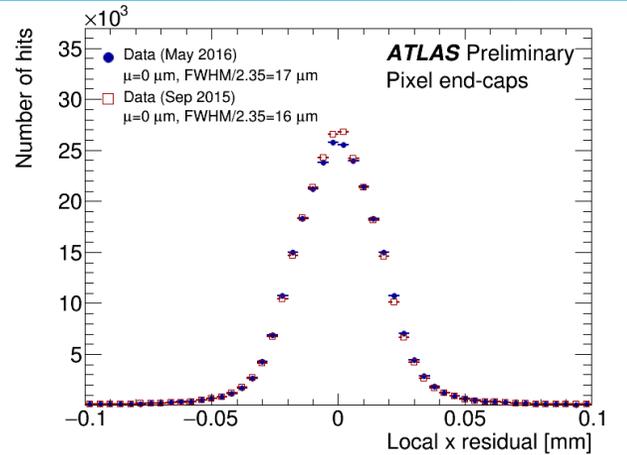
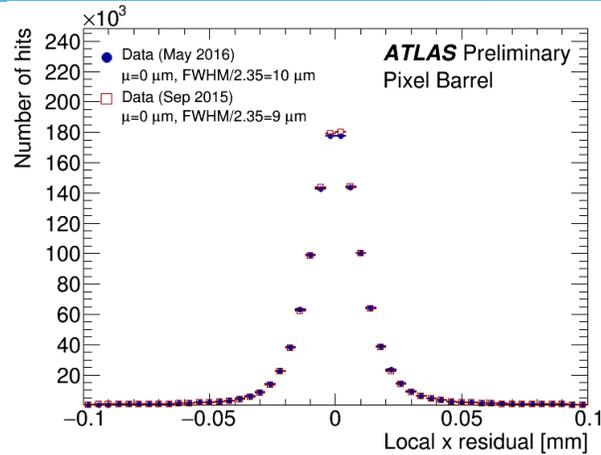
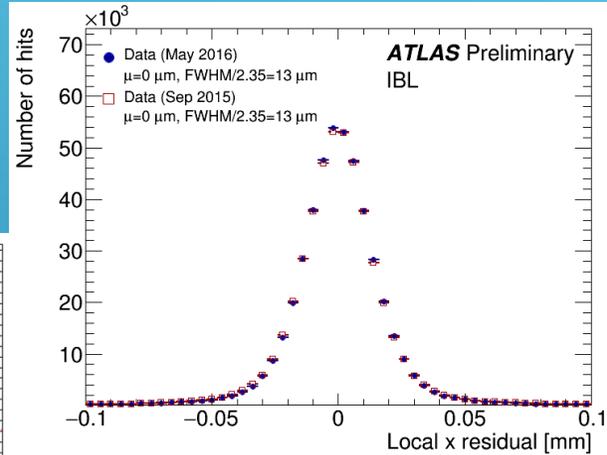
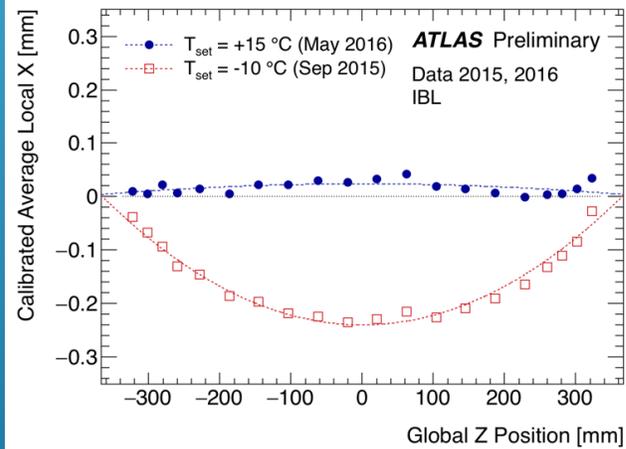
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- ▶ Tracking improvements immediately translate on b-tagging performance
- ▶ Run-2 vs Run-1 detector and reconstruction simulation comparison
  - ▶ better light and c-jet rejection over the whole acceptance and  $p_T$  spectrum allow +10% b-tag efficiency
    - ▶ in most analyses, this means moving from 70% to 77% efficiency for similar background rejection
  - ▶ IBL plays a role in low- $p_T$  rejection, while high- $p_T$  performance due to algorithm improvements

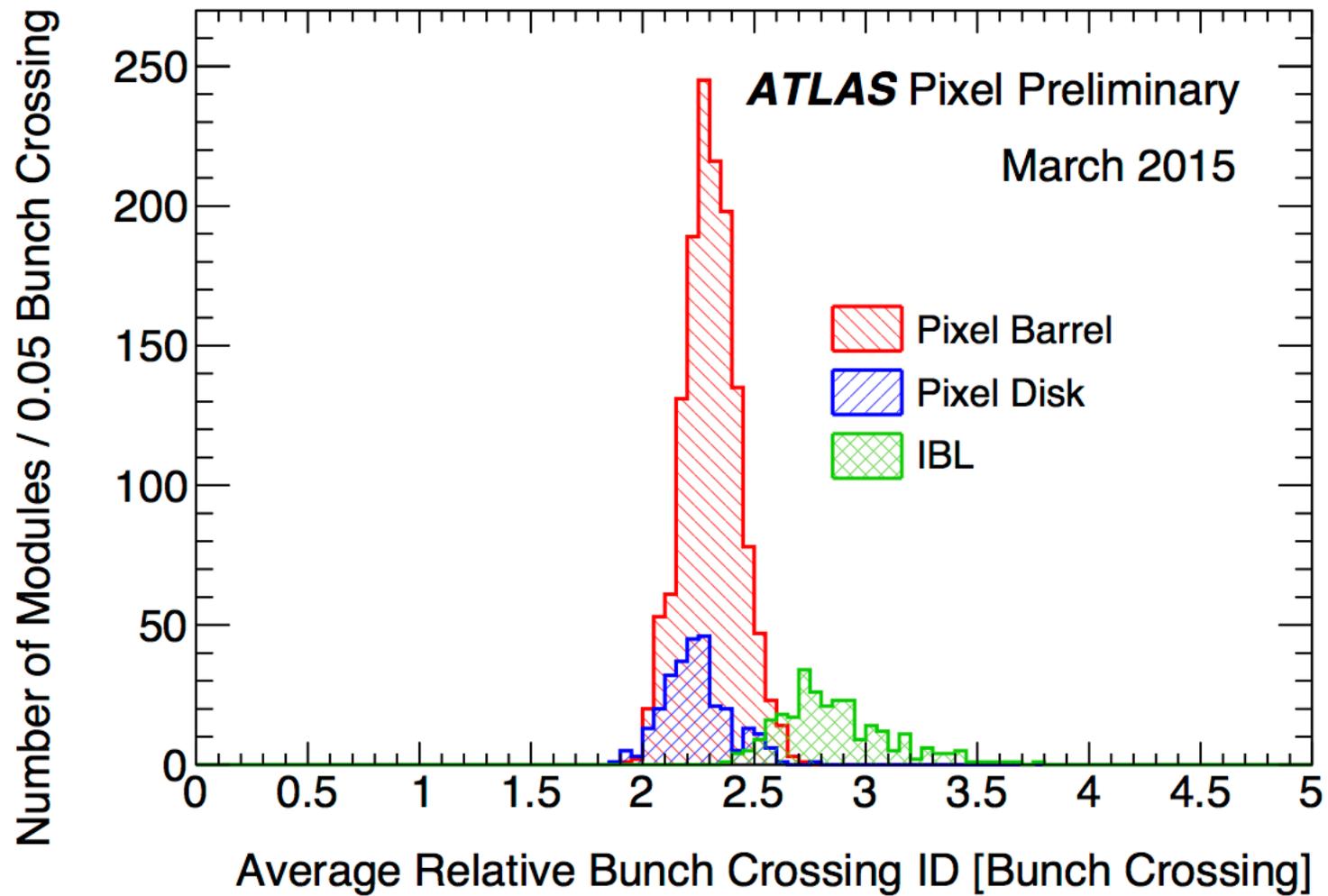


# BACK-UP: B-TAGGING PERFORMANCE

- ▶ Comparison based on two fills
- ▶ Very different operating temperature, very similar performance

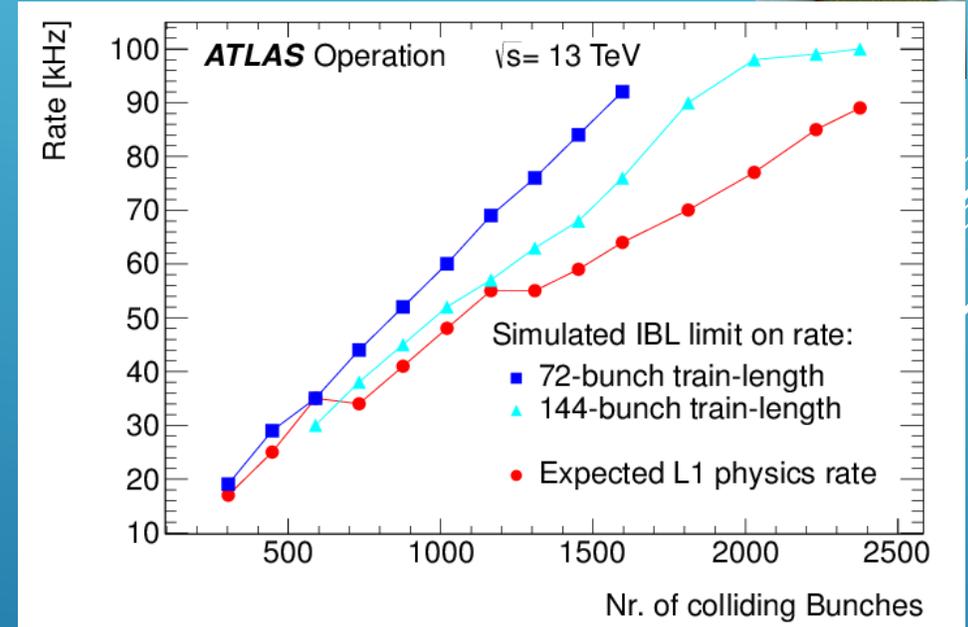
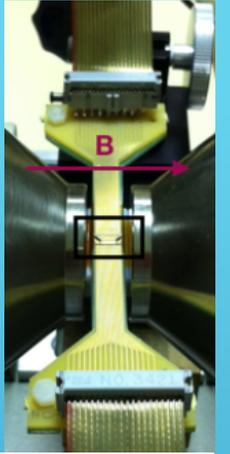


# BACK-UP: 2016 VS 2015 RESIDUALS



# BACK-UP: TIMING

- ▶ Before the start of Run-2, campaign to evaluate effects of magnetic field on wire bonds
  - ▶ ad-hoc PCB used for extensive testing
  - ▶ AC current mimicking trigger signal with varying frequency and direction wrt magnetic field
  - ▶ lab measurements proved that induced oscillations can damage or break wires or their bonds
  - ▶ observations confirmed by FEA simulations
  - ▶ triggering at wire resonant frequencies (with harmonics and sub-harmonics) must be avoided
- ▶ Protective countermeasure: Fixed Frequency Trigger Veto implemented in DAQ chain/calibration
  - ▶ sustainable trigger rate depends on LHC filling scheme and bunch pattern
  - ▶ never a limitation in data taking, in particular with filled machine (definitely the case in 2016)
  - ▶ impact of protection decreases with number of bunches in the LHC, not a concern any longer
  - ▶ still an effective protection in pathological situations



# BACK-UP: IBL WIRE BONDS PROTECTION